

Application Data Sheet
APPLICATION INFORMATION

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?::

Computer Readable From (CRF)?:: No

Number of Copies of CRF::

Title:: LEAD FORMING FOR A SEMICONDUCTOR
DEVICE

Attorney Docket Number:: 402698

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 10

Small Entity?:: No

Latin Name::

Variety denomination name::

Petition Included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?:: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Hidetaka
Middle Name::
Family Name:: YAMASAKI
Name Suffix::
City of Residence:: Hyogo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Device Design Corporation
61-5, Higashino 4-chome
City of mailing address:: Itami City
State or Province of mailing address:: Hyogo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 664-0004

Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Itaru
Middle Name::
Family Name:: MATSUO
Name Suffix::
City of Residence:: Tokyo
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Technology Corp.
4-1, Marunouchi 2-chome, Chiyoda-ku
City of mailing address:: Tokyo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 100-6334

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Hidekazu
Middle Name::
Family Name:: MANABE
Name Suffix::
City of Residence:: Tokyo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Technology Corp.
4-1, Marunouchi 2-chome, Chiyoda-ku
City of mailing address:: Tokyo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 100-6334

Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Kenji
Middle Name::
Family Name:: IMAMURA
Name Suffix::
City of Residence:: Tokyo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Technology Corp.
4-1, Marunouchi 2-chome, Chiyoda-ku
City of mailing address:: Tokyo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 100-6334

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Kenichirou
Middle Name::
Family Name:: KATOU
Name Suffix::
City of Residence:: Hyogo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Device Design Corporation
61-5, Higashino 4-chome
City of mailing address:: Itami City
State or Province of mailing address:: Hyogo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 664-0004

Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Mitsutaka
Middle Name::
Family Name:: MATSUO
Name Suffix::
City of Residence:: Hyogo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Device Design Corporation
61-5, Higashino 4-chome
City of mailing address:: Itami City
State or Province of mailing address:: Hyogo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 664-0004

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 23548
Phone:: (202) 737-6770
Fax:: (202) 737-6776
E-mail Address:: dcmail2@leydig.com

REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2003-1242	01/07/03	Yes

ASSIGNEE INFORMATION

Assignee name:: Renesas Technology Corp.

Street of mailing address:: 4-1, Marunouchi 2-chome
Chiyoda-ku

City of mailing address:: Tokyo

State or Province of
mailing address::

Country of mailing
address:: Japan

Postal or Zip Code of
mailing address:: 100-6334

Assignee name:: Renesas Device Design Corporation

Street of mailing address:: 61-5, Higashino 4-chome

City of mailing address:: Itami City

State or Province of
mailing address:: Hyogo

Country of mailing
address:: Japan

Postal or Zip Code of
mailing address:: 664-0004